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DATA SHEET

PART NO.: LJS5UBTC318

REV : <u>A/0</u>

PARA LIGHT ENGINEERING:_____

CUSTOMER'S APPROVAL:_

DRAWING NO. : DS-34-09-0050

DATE : 2009-08-28

DCC:

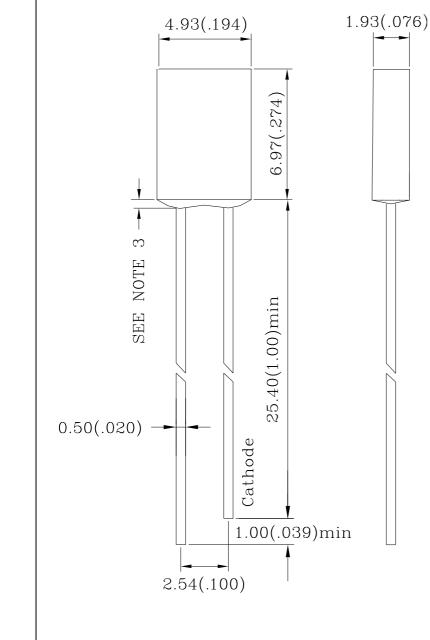


LJS5UBTC318

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PACKAGE DIMENSIONS

ITEM	MATERIALS
RESIN	Epoxy Resin
LEAD FRAME	Sn Plating iron Alloy



Note:

1.All Dimensions are in millimeters.

- 2.Tolerance is ±0.25mm(0.010 ") Unless otherwise specified.
- 3. Protruded resin under flange

is 1.5mm(0.059 ") max.



LJS5UBTC318

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FEATURES

- * High-brightness
- * High reliability
- * Low-voltage characteristics
- * Wide Viewing Angle
- * Pb FREE Products
- * RoHS Compliant

CHIP MATERIALS

- * Dice Material : GaInN/GaN
- * Light Color : ULTRA BLUE
- * Lens Color : WATER CLEAR

ABSOLUTE MAXIMUM RATING : (Ta = 25°C)

SYMBOL	DESCRIPTION	ULTRA BLUE	UNIT
PD	Power Dissipation Per Chip	120	mW
Vr	Reverse Voltage Per Chip	5	V
lf	Average Forward Current Per Chip	30	mA
IFP	Pulse Forward Current	100	mA
-	Derating Linear From 25°C Per Chip	0.4	mA/°C
Topr	Operating Temperature Range	-25°C t	o 85°C
Tstg	Storage Temperature Range	-25°C to 85°C	
Esd	the led can withstand the max static level	<3000V	
LSu	when assembling or operation (HBM)		

IFP Condition : Pulse Width≤10msec, 10% duty cycle

ELECTRO-OPTICAL CHARACTERISTICS : (Ta = 25°C)

		TEST	N 41N I	TVD	NAAX	
SYMBOL	DESCRIPTION	CONDITION	MIN.	TYP.	MAX.	UNIT
VF	Forward Voltage	IF = 20mA		3.5	4.0	V
IR	Reverse Current	VR = 5V			100	μA
λD	Dominant Wavelength	IF = 20mA		470		nm
Δλ	Spectral Line Half-Width	IF = 20mA		30		nm
201/2	Half Intensity Angle	IF = 20mA		80		deg
١v	Luminous Intensity	IF = 20mA		650		mcd

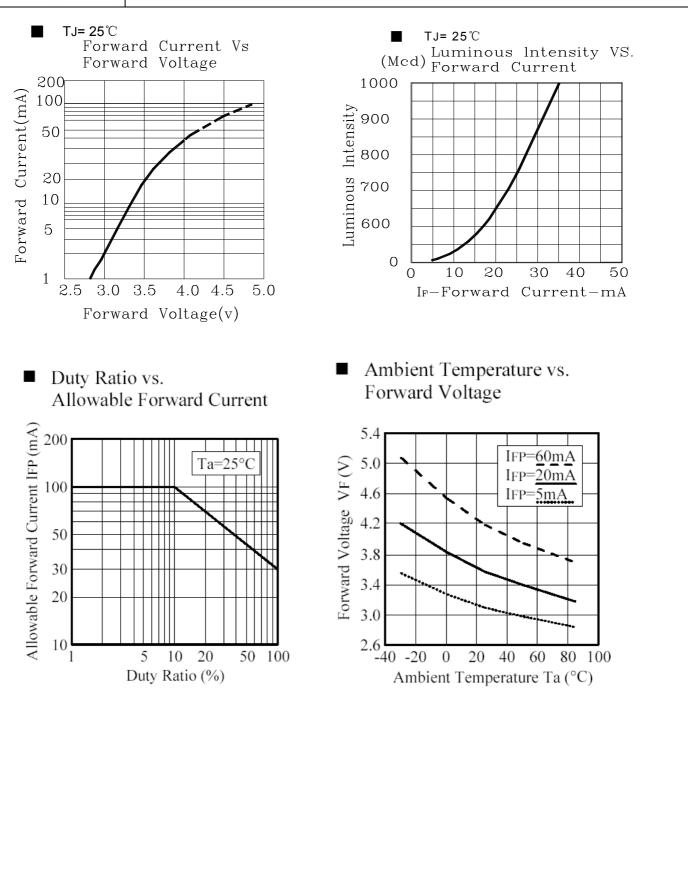
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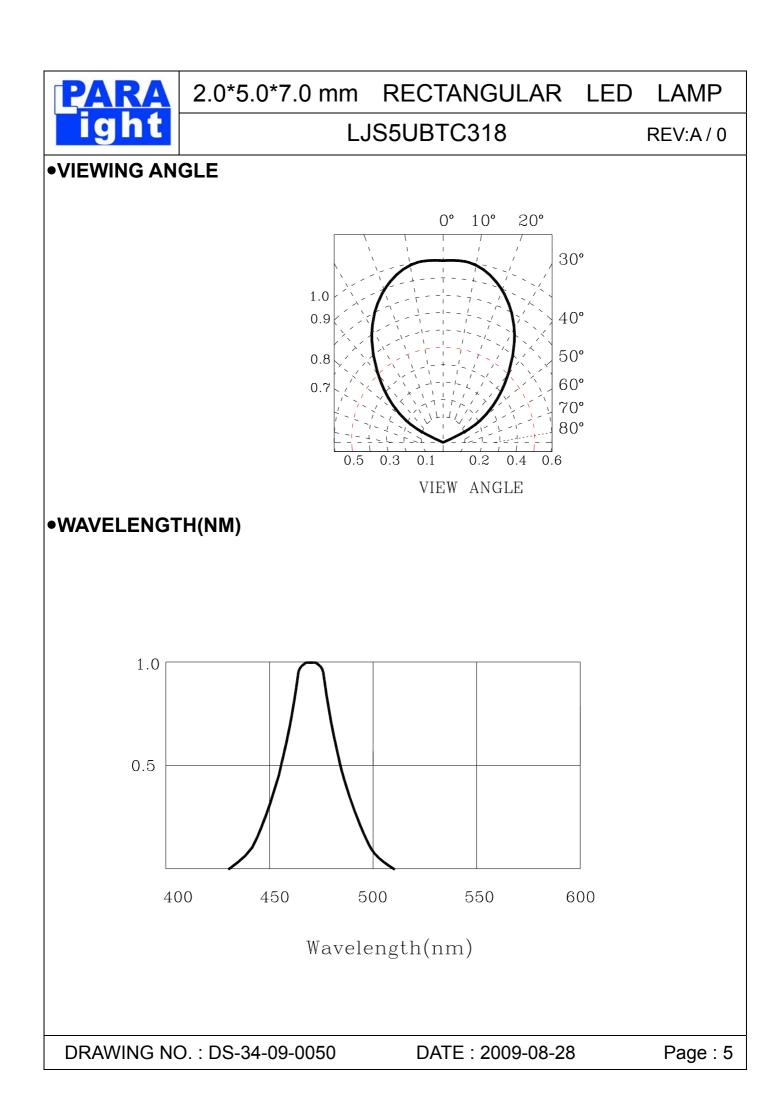
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Label Explanation



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•SOLDERING

METHOD	SOLDERING CONDITIONS	REMARK	
IR REFLOW	Bath temperature:260℃ Immersion time: within 5 sec,1time	 Solder no closer than 3mm from the base of the package Using soldering flux," RESIN FLUX" is recommended. 	
	Bath temperature: 260°C	•Attached data of temperatuare cure	
SOLDERING SOLDERING IRON	Immersion time: within 5 sec ,1time Soldering iron: 30W or smaller Temperature at tip of iron: 300°C or lower Soldering time: within 3 sec.	 for your reference on page 14 During soldering, take care not to press the tip of iron against the lead. (To prevent heat from being transferred directly to the lead, hold the lead with a pair of tweezers while soldering) 	
1) When solderi	ng the lead of LED in a condition that the	package is fixed with a panel (See Fig.1),	
be careful not to stress the leads with iron tip. Image: stress the leads with iron tip. Image: stress the leads with iron tip. Image: stress the leads with iron tip. Image: stress the leads with iron tip. Image: stress the leads with iron tip. Image: stress the leads with iron tip. Image: stress the leads with iron tip. Image: stress the leads with iron tip. Image: stress the leads with iron tip. Image: stress the leads with iron tip. Image: stress the leads with iron tip. Image: stress the leads with iron tip. Image: stress the leads with iron tip. Image: stress the leads with iron tip. Image: stress the leads with iron tip. Image: stress the leads with iron tip. Image: stress the leads with iron tip. Image: stress the leads with iron tip. Image: stress the leads with iron tip. Image: stress the leads with iron tip. Image: stress the leads with iron tip. Image: stress the leads with iron tip. Image: stress the leads with iron tip. Image: stress the leads with iron tip. Image: stress the leads with iron tip. Image: stress the leads with iron tip. Image: stress the leads with iron tip. <t< td=""></t<>			
Regarding tinning the leads, compound made of tin ,copper and sliver is proposed with the temperature of 260°C. The proportion of the alloyed solution is 95.5% tin, 3.5% copper, 0.5% silver. The time of tinning is 3 seconds.			
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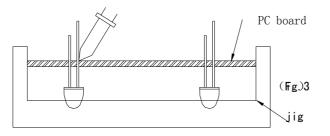
•

2.0*5.0*7.0 mm RECTANGULAR LED LAMP

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3) Similarly, when a jig is used to solder the LED to PC board, take care as much as possible to avoid stressing the leads (See Fig.3).



- Repositioning after soldering should be avoided as much as possible. If inevitable: select a best-suited method that assures the least stress to the LED.
- Lead cutting after soldering should be performed only after the LED temperature has returned to normal temperature.

• STORAGE

- 1) The LEDs should be stored at 30° C or less and 70% RH or less after being shipped from PARA and the storage life limit is 1 year .
- 2) PARA LED lead frames are comprised of a tin plated iron alloy. The surface may be affected by environments which contain corrosive gases and so on. Please avoid conditions which may cause the LEDs to corrode, tarnish or discolor. This corrosion or discoloration may cause difficulty during soldering operations. It is recommended that the LEDs be used as soon as possible.
- 3) Please avoid rapid changes in ambient temperature, especially, in high humidity environments where condensation can occur.

PARA ight

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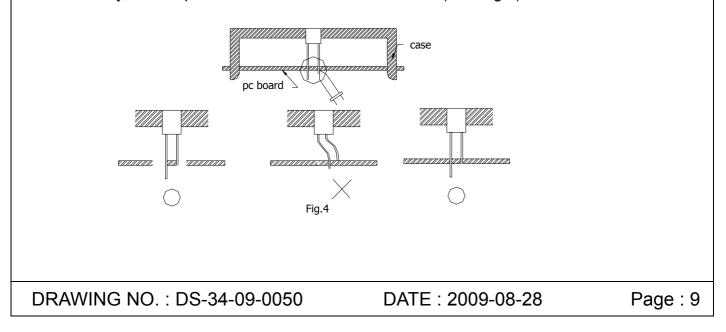
• STATIC ELECTRICITY

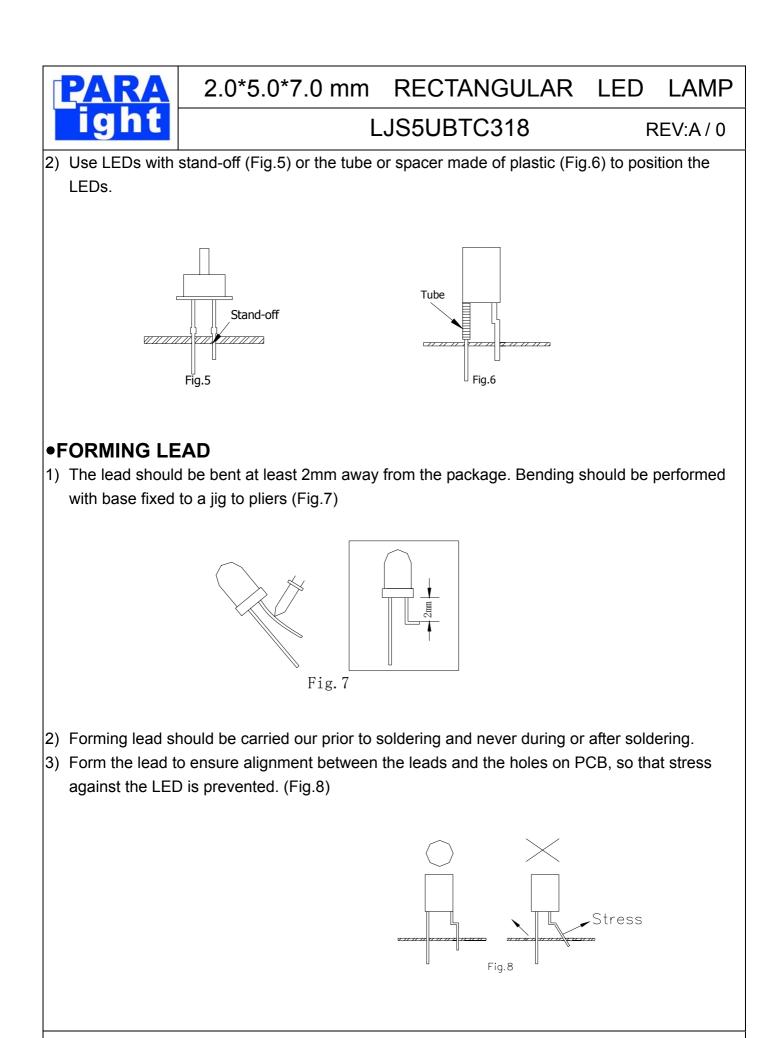
- Static electricity or surge voltage damages the LEDs.
 It is recommended that a wrist band and an anti-electrostatic glove be used when handling the LEDs.
- 2) All devices, equipment and machinery must be properly grounded. It is recommended that measures be taken against surge voltage to the LED mounting equipment.
- 3) When inspecting the final products in which LEDs were assembled, it is recommended to check whether the assembled LEDs are damaged by static electricity. To find static-damaged LEDs, perform a light-on test or a VF test at a lower current (below 1mA is recommended).
- 4) Damaged LEDs will show some unusual characteristics such as the leakage current remarkably increases, the forward voltage becomes lower, or the LEDs do not light at the low current.

Criteria : (VF>2.0V at IF=0.5mA)

•LED MOUNTING METHOD

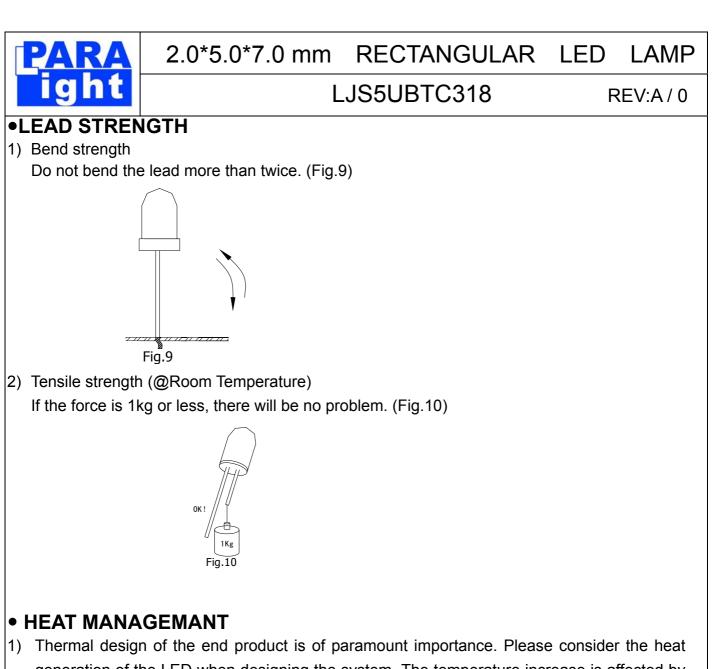
1) When mounting the LED to a housing, as shown on Fig.4, ensure that the mounting holes on the PC board match the pitch of the leads correctly. Tolerance of dimensions of the respective components including the LEDs should be taken into account especially when designing the housing, PC board, etc. to prevent pitch misalignment between the leads and holes on PCB, the diameter of the holes should be slightly larger than the size of the lead. Alternatively, the shape of the holes could be made oval. (See Fig.4)





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- generation of the LED when designing the system. The temperature increase is affected by the thermal resistance of the circuit board and density of LED placement on the board, as well as other components. It is necessary to avoid intense heat generation and operate within the maximum ratings given in this specification.
- The operating current (IF) should be decided after considering the ambient maximum temperature of LEDs.

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•CHEMICAL RESISTANCE

- 1) Avoid exposure to chemicals as it may attack the LED surface and cause discoloration.
- When washing is required, refer to the following table for the proper chemical to be used. (Immersion time: within 3 minutes at room temperature.)

SOLVENT	ADAPTABILITY
Freon TE	\odot
Chlorothene	\times
Isopropyl Alcohol	\odot
Thinner	\times
Acetone	\times
Trichloroethylene	X
	1

NOTE: Influences of ultrasonic cleaning of the LED resin body differ depending on factors such as the oscillator output, size of the PC board and the way in which the LED is mounted. Therefore, ultrasonic cleaning should only be performed by confirming an ultrasonic cleaning trial run.

 \odot --Usable X--Do not use.

•OTHER CONSIDERTIONS

- 1) Care must be taken to ensure that the reverse voltage will not exceed the absolute maximum rating when using the LEDs with matrix drive.
- 2) The LEDs described in this data sheet are intended to be used for ordinary electronic equipment (such as office equipment, communications equipment, measurement instruments and household appliances). Consult PARA's sales staff in advance for information on the applications in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as for airplanes, spacecraft, automobiles, traffic control equipment etc).
- 3) The formal specifications must be exchanged and signed by both parties before large volume purchase begins.



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Bin Code List

Forward Voltage (VF), Unit:v@20mA			
Bin Code	Min	Max	
V0	2.8	3.0	
V1	3.0	3.2	
V2	3.2	3.4	
V3	3.4	3.6	
V4	3.6	3.8	
V5	3.8	4.0	

Tolerance of each bin are±0.1Volt

Dominant Wavelength(λD), Unit:nm@20mA			
Bin Code	Min	Max	
D4	463	466	
D5	466	469	
D6	469	472	
D7	472	474	
D8	474	476	

Tolerance of each bin are±1mn

Luminous Intensity(IV), Unit:mcd@20mA			
Bin Code	Min	Max	
D	280	390	
E	390	550	
F	550	770	
G	770	1080	
Н	1080	1510	

Tolerance of each bin are±15%

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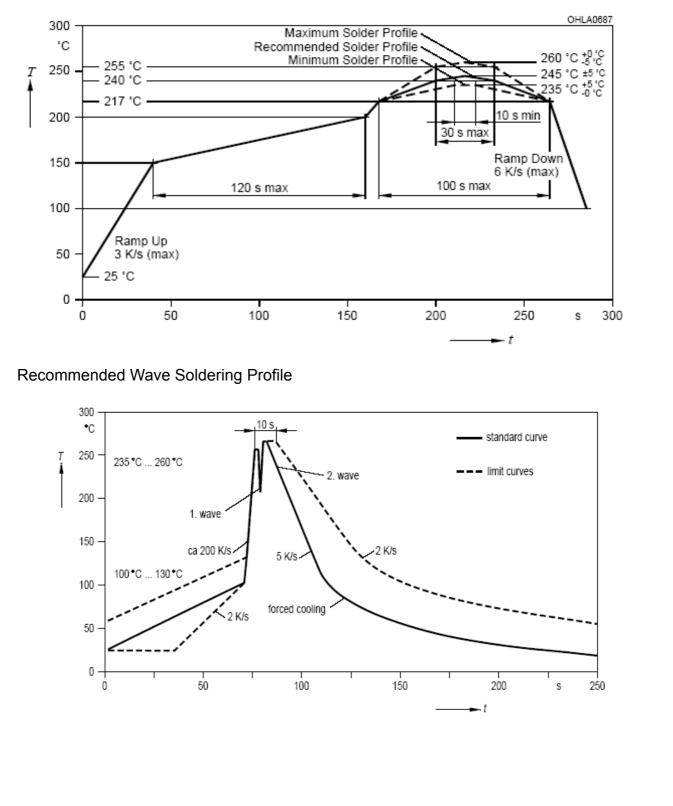
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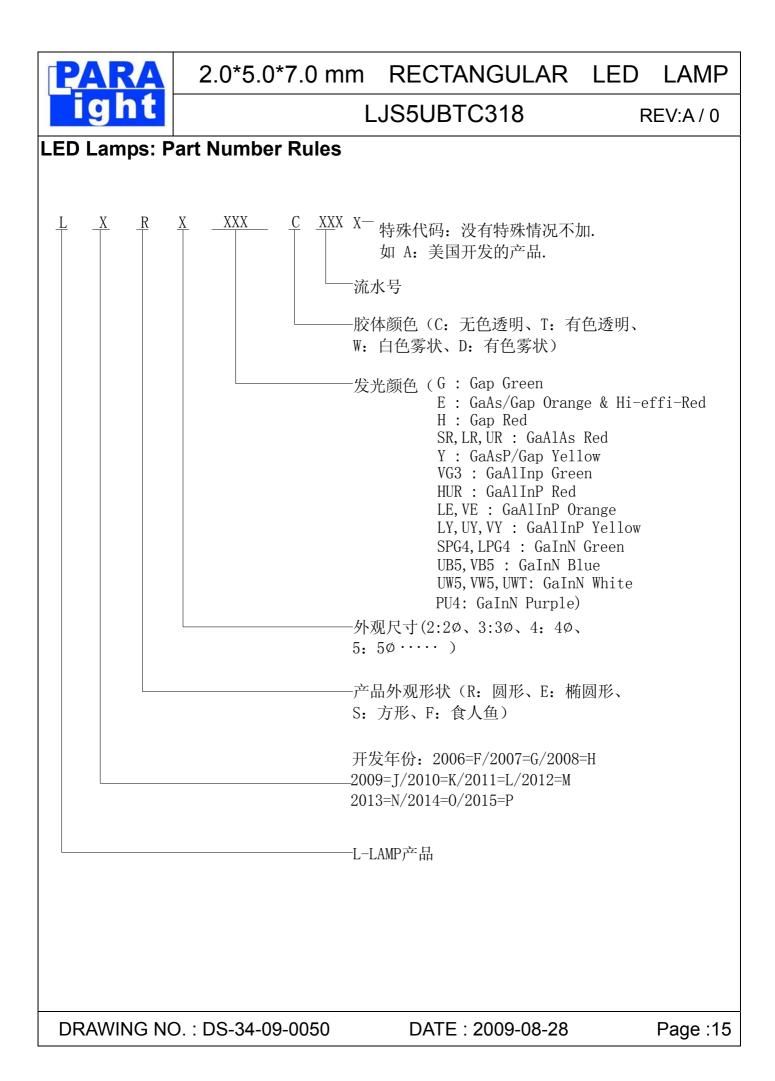


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